

**The Appendix is an integral part of
Certificate of Accreditation No. 423/2022 of 26/08/2022**

Accredited entity according to ČSN EN ISO/IEC 17025:2018:

G. L. Electronic s.r.o.
G. L. Electronic Testing Laboratory
Podnikatelská 2902/4, 612 00 Brno – Královo Pole

Testing laboratory locations:

1. **Mechanics Laboratory** Podnikatelská 2902/4, 612 00 Brno – Královo Pole
2. **Metallographic Laboratory** Podnikatelská 2902/4, 612 00 Brno – Královo Pole

1. **Mechanics Laboratory**

Tests:

Ordinal number ¹	Test procedure/method name	Test procedure/method identification ²	Tested object
1	Tensile Strength Test	TSTP-01-GLE (ECSS-Q-ST-70-26 C Rev.1)	Wires, crimped joints
2	Voltage Drop Test	VDTP-01-GLE (ECSS-Q-ST-70-26 C:2008)	Crimped joints

¹ asterisk at the ordinal number identifies the tests, which the Laboratory is qualified to carry out outside the permanent laboratory premises

² if the document identifying the test procedure is dated, only these specific procedures are used. If the document identifying the test procedure is not dated, the latest edition of the specified procedure is used (including any changes)

2. **Metallographic Laboratory**

Tests:

Ordinal number ¹	Test procedure/method name	Test procedure/method identification ²	Tested object
1	Metallographic Microsection	MMP-01-GLE (ECSS-Q-ST-70-26 C Rev.1)	Crimped joints

¹ asterisk at the ordinal number identifies the tests, which the Laboratory is qualified to carry out outside the permanent laboratory premises

² if the document identifying the test procedure is dated, only these specific procedures are used. If the document identifying the test procedure is not dated, the latest edition of the specified procedure is used (including any changes)

Explanatory notes:

TSTP – Internal Testing Procedure

VDTP – Internal Testing Procedure

MMP – Internal Testing Procedure

ECSS – ESA standard pro crimped joints